



Hardware User's Manual

IFB125



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Safety Precautions

Before getting started, please read the following important safety precautions.

- 1. Be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and place all electronic components in any static-shielded devices. Most electronic components are sensitive to static electrical charge.
- Disconnect the power cord from the IFB125 before making any installation. Be sure both the system and the external devices are turned OFF. Sudden surge of power could ruin sensitive components. Make sure the IFB125 is properly grounded.
- 3. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
- 4. Turn OFF the system power before cleaning. Clean the system using a cloth only. Do not spray any liquid cleaner directly onto the screen.
- 5. Do not leave this equipment in an uncontrolled environment where the storage temperature is below -45 $^{\circ}$ C or above 85 $^{\circ}$ C. It may damage the equipment.
- 6. Do not open the system's back cover. If opening the cover for maintenance is a must, only a trained technician is allowed to do so. Integrated circuits on computer boards are sensitive to static electricity. To avoid damaging chips from electrostatic discharge, observe the following precautions:
 - Before handling a board or integrated circuit, touch an unpainted portion of the system unit chassis for a few seconds. This will help to discharge any static electricity on your body.
 - When handling boards and components, wear a wrist-grounding strap, available from most electronic component stores.

Classification

- 1. Degree of production against electric shock: not classified
- 2. Equipment not suitable for use in the presence of a flammable anesthetic mixture with air or with oxygen or nitros oxide.
- 3. Mode of operation: Continuous
- 4. Type of protection against electric shock: Class I equipment

General Cleaning Tips

You may need the following precautions before you begin to clean the computer. When you clean any single part or component for the computer, please read and understand the details below fully.

When you need to clean the device, please rub it with a piece of dry cloth.

- 1. Be cautious of the tiny removable components when you use a vacuum cleaner to absorb the dirt on the floor.
- 2. Turn the system off before you start to clean up the component or computer.
- 3. Never drop the components inside the computer or get circuit board damp or wet.
- 4. Be cautious of all kinds of cleaning solvents or chemicals when you use it for the sake of cleaning. Some individuals may be allergic to the ingredients.
- 5. Try not to put any food, drink or cigarette around the computer.

Cleaning Tools

Although many companies have created products to help improve the process of cleaning your computer and peripherals users can also use household items to clean their computers and peripherals. Below is a listing of items you may need or want to use while cleaning your computer or computer peripherals.

Keep in mind that some components in your computer may only be able to be cleaned using a product designed for cleaning that component, if this is the case it will be mentioned in the cleaning.

- Cloth: A piece of cloth is the best tool to use when rubbing up a component. Although paper towels or tissues can be used on most hardware as well, we still recommend you to rub it with a piece of cloth.
- Water or rubbing alcohol: You may moisten a piece of cloth a bit with some water or rubbing alcohol and rub it on the computer. Unknown solvents may be harmful to the plastics parts.
- Vacuum cleaner: Absorb the dust, dirt, hair, cigarette particles, and other particles out of a computer can be one of the best methods of cleaning a computer. Over time these items can restrict the airflow in a computer and cause circuitry to corrode.
- Cotton swabs: Cotton swaps moistened with rubbing alcohol or water are excellent tools for wiping hard to reach areas in your keyboard, mouse, and other locations.
- Foam swabs: Whenever possible it is better to use lint free swabs such as foam swabs.



We strongly recommended that you should shut down the system before you start to clean any single components.

Please follow the steps below:

- 1. Close all application programs
- 2. Close operating software
- 3. Turn off power
- 4. Remove all device
- 5. Pull out power cable

Scrap Computer Recycling

If the computer equipments need the maintenance or are beyond repair, we strongly recommended that you should inform your Axiomtek distributor as soon as possible for the suitable solution. For the computers that are no longer useful or no longer working well, please contact your Axiomtek distributor for recycling and we will make the proper arrangement.

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CHAPTER 1 INTRODUCTION

This chapter contains general information and detailed specifications of the IFB125. The Chapter 1 includes the following sections:

- General Description
- System Specification
- Dimensions
- I/O Outlets
- Packing List

1.1 General Description

IFB125 cost-effective din-rail fanless embedded system utilizes the low power RISC-based module (iMX6UL) processor and is designed to withstand temperatures ranging from -40°C to +70°C for using in extreme operating environment and industrial automation applications.

IFB125 features 2 RS-232/422/485 serial ports, dual LANs, 1 DIO Port (2-In/1-Out), 1 eMMC onboard 8GB for storage. Its vertical din-rail form factor makes it easy to install the system in a small cabinet. Due to the RISC-based architecture, IFB125 will not generate a lot of heat while being operated.

• Features

- Fanless
- Wide temperature operation of -40°C +70°C
- Low power RISC-based module (i.MX6UL), 528MHz Processor
- 2 x 10/100Mbps Ethernets with magnetic isolation protection
- 1 x COM Ports
- 1 x SPI
- 1 x l2C
- 1 x Power output(3.3V@0.5A)
- 1 x USB 2.0 with power distribution control and over current protection
- 1 x DIO Port (2-In/1-Out) with Wet contacts
- 1 x Console Port for debug settings
- 1 x Watchdog Timer
- LED Indicators (for user config)
- Storage:
 - Support one eMMC 8GB onboard (for boot disk)
- 1 power paths with terminal block and 9–48VDC
- Din-rail mounting

1.2 System Specifications

1.2.1 CPU

 Low power RISC-based module (iMX6UL), ARM Cortex-A7 RISC-based 528MHz Processor

1.2.2 System Memory

• 1 x DDR3 256MB SDRAM onboard

1.2.3 Console Port

- For user debug settings
- Connected to DIO terminal Block

1.2.4 LAN

- LAN 1 / LAN 2
 - 10/100Mbps LAN w/ magnetic isolation protection 1.5KV
 - 10/100Mbps LAN w/ magnetic isolation protection 1.5KV

1.2.5 Storage

• 1 x eMMC 8GB onboard (for boot disk)

1.2.6 USB

• 1 x USB2.0 port

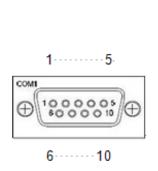
1.2.7 WatchDog Timer (WDT)

• 1 x WatchDog Timer

1.2.8 COM

- DB9 Pin define
- RS232/RS422/RS485
- COM with TX/RX/RTS/CTS signals
- RS-232/422/485 Interface select by software

Pin	RS-232	RS-422	RS-485
1		TX-	Data-
2	RX	TX+	Data+
3	ТХ	RX+	
4		RX-	
5	Ground	Ground	Ground
6			
7	RTS		
8	CTS		
9			



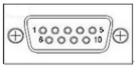
1.2.9 SPI & I2C

- DB9 Pin define
- 1 x SPI function with one chip select
- 1 x I2C function

D-sub9 pin define

Pin	3.3V power output	SPI	12C
1		CLK	
2		SS	
3		MOSI	
4		MISO	
5	PWR GND		
6		SIG GND	SIG GND
7			SDA
8			SCL
9	3.3V		

1-----5



6.....10

1.2.10 Power

- DC input range 9~48V
- Power consumption 9~48VDC, 0.55A~0.1A
 - 0.55A@9V
 - 0.1A@48V
 - 0.4A@12V
- DC Terminal Block

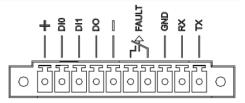
Pin	DC Signal Name	÷ R
1	Power+	
2	-	$\circ \bigsqcup \bigsqcup \circ$
3	Power-	1 2 3

1.2.11 Digital I/O,Relay,Console Connector and Pin Definition

- 2 DI/ 1DO
- DI: Wet/Dry
- DO: Wet
- DIO Design Specification

Digital Input		
Input Channels	2,source type	
Input Voltage	0 to 24VDC	
Digital Input Levels for Dry Contacts	Logic level 0:Close to GND	
	Logic level 1:Open	
Digital Input Levels for Wet Contacts	Logic level 0: Close to GND	
	Logic level 1:+0.7~+24V max.	
Digital Output		
Output Channels	1,sink type	
Output Current	Max. 200 mA per channel	
On-state Voltage	24VDC nominal	

• DIO 2-IN/1-OUT of TB10 Female with relay and comsole port.

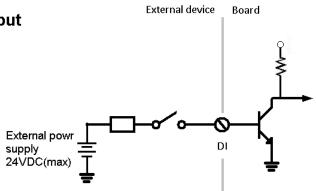


IFB125 DIO Terminal Block

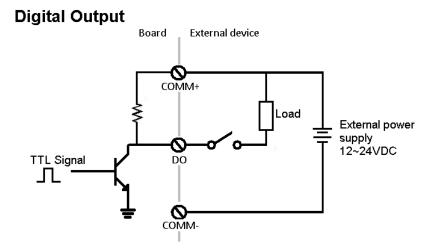
TB18 Pin No.	Signal name	Meaning
1	COM+	Plus Common for DIO
2	DI0	Disitel Insut
3	DI1	Digital Input
4	DO	Digital Output
5	COM-	Minus Common for DIO
6	Relay+	Delay Out
7	Relay-	Relay Out
8	GND	
9	Console RX	Console Port
10	Console TX	

• DIO operation schematic diagram Input Circuit

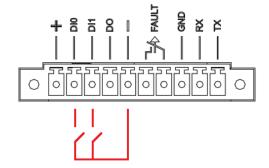
Digital Input



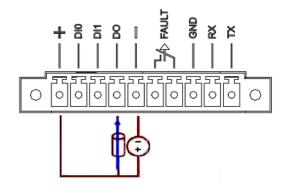
Output Circut



Digital Input Wiring



• Digital Output Wiring

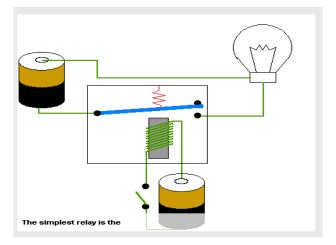


• Relay output with 0.5A @30VDC

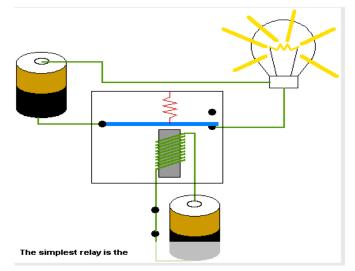
Relay output

There is a very simple application for remote notice that uses relay and lamp as below.

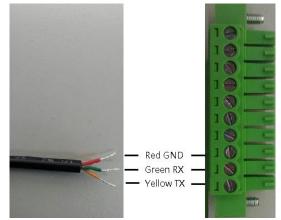
1. Normal



2. Warning



• Console cable pin definition



• DIO Terminal Block

TB10 Pin No.	Signal name	Meaning
1	COM+	Plus Common for DIO
2	DI0	Disitel la sut
3	DI1	Digital Input
4	DO	Digital Output
5	COM-	Minus Common for DIO
6	Relay+	Data: Out
7	Relay-	Relay Out
8	GND	
9	Console RX	For Console Port
10	Console TX	

1.2.12 System LED

LED Name	Description	Color	Note
The LED can help users to judge boot finish not and the OS can normal work or not.			
Status	When the boot finishing the configuration of system, the LED will turn ON.	Green	
	- The LED is blinking, Bootloader or Linux kernel loading.		
	- The LED always ON, system ready.		
1~4	GPIO LED for user configuration	Green	

1.2.13 Wireless (3G/GPRS or Wifi)

- 1 x Mini card socket 1 (supports USB&PCIE interface) with 1 x SIM Card Socket 1 by inside
- Support WiFi or 3G/GPRS2

1.2.14 Reset Button

• 1 x Reset button

1.2.15 Operation Temperature

• -40°C ~ +70°C (-40 °F ~ +158°F)

1.2.16 Storage Temperature

• -45°C ~ +85°C (-49 ⁰F ~ +185⁰F)

1.2.17 Humidity

• 10% ~ 95% (non-condensation)

1.2.18 Weight

• 1kg

1.2.19 Dimensions

• 31mm(W)x100mm(D)x125mm(H)

1.2.20 System I/O Outlet

- 1 x DB9 connectors for I2C and SPI function
- 1 x COM port
- 1 x Console Port
- 2 x 10/100Mbps Ethernets with magnetic isolation protection
- 1 x USB 2.0 with power distribution control and over current protection
- 1 x DIO Port (2-In/1-Out) with Wet contacts
- DC Powers Input with terminal block
- Relay out

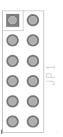
All specifications and images are subject to change without notice.

Note

1.3 Jumper setting

1.3.1 JP1

Function	Setting
Copy image to eMMC	JP1 1-2 Close
Boot to OS (IFB125 eMMC) (Default)	JP2 3-4,5-6 Close JP2 7-8, 11-12 Close
Boot to OS (IFB125 SD Card)	JP2 3-4, 9-10 Close



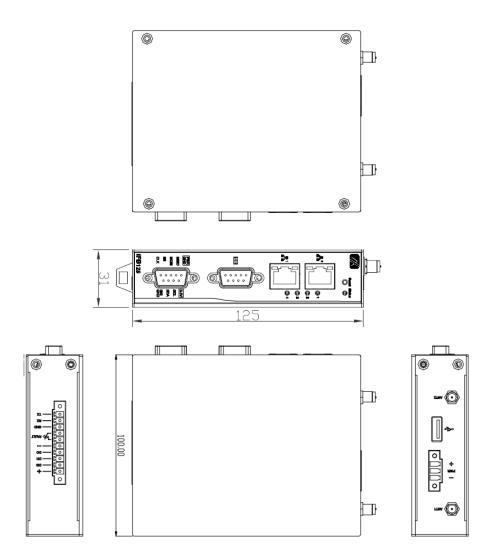
1.3.2 JP3

Function	Setting
OTG Client	JP3 1-2 Close
OTG Host	JP3 2-3 Close
(Default)	



1.4 Dimensions

The following diagrams illustrate dimensions and outlines of the IFB125



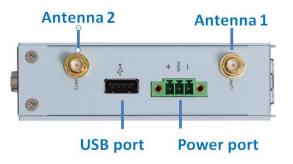
1.5 I/O Outlets

The following figures help you locate I/O outlets on the front top and bottom of the IFB125IFB125.

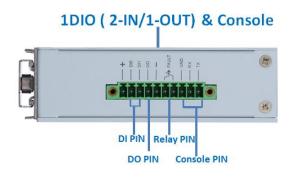
• Front View



• Top View



Bottom View



1.6 Packing List

The package bundled with your IFB125 should contain the following items:

- IFB125 System Unit x 1
- Din-rail Kit x 1
- Power terminal block x 1
- DIO terminal block x 1
- Console cable x 1

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CHAPTER 2 HARDWARE INSTALLATION

2.1 Installing Din-rail Mounting

The IFB125 provides a Din-rail Mount that can be installed as the picture below illustrates:

Note: Prior to installation, make sure you have all of the required DIN Mount assembling components (screws and bracket) ready.



2.2 Installing Wall Mounting (Opitonal)

The IFB125 provides a Wall Mounting bracket that customers can install as the picture below illustrates:

Note: Prior to installation, make sure you have all of the required wall mount assembling components (screws and bracket) ready.

Attach the bracket to the system and fasten all of the screws firmly.



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